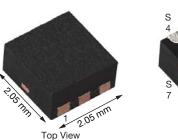
SiA468DJ **Vishay Siliconix**

www.vishay.com

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) (MAX.)	I _D (A) ^a	Q _g (TYP.)		
30	0.0084 at V _{GS} = 10 V	37.8	8.2 nC		
	0.0114 at V _{GS} = 4.5 V	32.5	0.2 110		

PowerPAK[®] SC-70-6L Single





Marking Code: AX

Ordering Information:

SiA468DJ-T1-GE3 (lead (Pb)-free and halogen-free)

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- 100 % R_g tested
- COMPLIANT • The highest continuous drain current capability HALOGEN in its class FREE
- Very low R_{DS}-Q_q FOM and Q_{ad} elevate efficiency
- Increase power density of your design
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- DC/DC converters and synchronous buck converters
- Lower ringing voltage from soft turn-on - High efficiency from fast turn-off
- Lower shoot-through possibility
- · Battery charging and protection
- Load switch

N-Channel MOSFET

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ABSOLUTE MAXIMUM RATINGS (T	_A = 25 °C, unless	otherwise noted	(k		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	+20 / -16	v	
	T _C = 25 °C		37.8		
Continuous Drain Current (T 150 °C)	T _C = 70 °C		36.3		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	16.1 ^{a, b}		
	T _A = 70 °C		12.9 ^{a, b}	A	
Pulsed Drain Current (t = 100 µs)		I _{DM}	70	7	
Continuous Source-Drain Diode Current	T _C = 25 °C		15.8		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.9 ^{a, b}		
	T _C = 25 °C		19		
Maximum Power Dissipation	T _C = 70 °C	D	12	w	
	T _A = 25 °C	P _D	3.5 ^{a, b}	vv	
	T _A = 70 °C		2.2 ^{a, b}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150		
Soldering Recommendations (Peak temperature) c, d			260	C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient a, e	t ≤ 5 s	R _{thJA}	28	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady state	R _{thJC}	5.3	6.5	C/W	

Notes

a. Surface mounted on 1" x 1" FR4 board.

b. t = 5 s.

- c. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

e. Maximum under steady state conditions is 80 °C/W.

S16-1266-Rev. A, 27-Jun-16

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RoHS

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	12.8	-		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.8	-	mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	-	2.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = +20 V / -16 V$	-	-	± 100	nA	
	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	10	-	-	А	
	_	V _{GS} = 10 V, I _D = 11 A	-	0.0070	0.0084	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$	-	0.0091	0.0114		
Forward Transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 11 A	-	35	-	S	
Dynamic ^b				<u> </u>			
Input Capacitance	C _{iss}		-	1290	-	pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	435	-		
Reverse Transfer Capacitance	C _{rss}		-	30	-		
	Qg	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 12 A	-	17.6	22		
Total Gate Charge			-	8.2	16		
Gate-Source Charge	Q _{qs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 12 \text{ A}$	-	3.1	-		
Gate-Drain Charge	Q _{gd}		-	1.3	-		
Gate Resistance	Rg	f = 1 MHz	0.28	1.4	2.8	Ω	
Turn-On Delay Time	t _{d(on)}		-	8	16		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$	-	22	40		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$	-	18	36		
Fall Time	t _f		-	8	16		
Turn-On Delay Time	t _{d(on)}		-	12	25	ns	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$	-	30	45		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10$ Å, $V_{GEN} = 4.5$ V, $R_g = 1$ Ω	-	15	30		
Fall Time	t _f		-	13	26		
Drain-Source Body Diode Characteristic	S				1		
Continuous Source-Drain Diode Current	Is	T _C = 25 °C	-	-	12		
Pulse Diode Forward Current ^a	I _{SM}		-	-	40	A	
Body Diode Voltage	V _{SD}	I _S = 10 A	-	0.85	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}		-	30	45	ns	
Body Diode Reverse Recovery Charge	Q _{rr}		-	20	35	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		17	-	1	
Reverse Recovery Rise Time	t _b		-	13	_	ns	

Notes

a. Pulse test; pulse width \leq 100 $\mu s,$ duty cycle \leq 2 %.

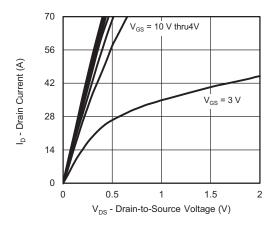
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

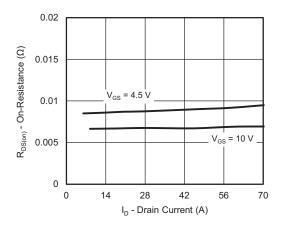
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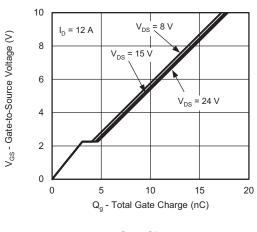
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



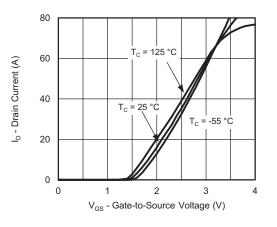
Output Characteristics



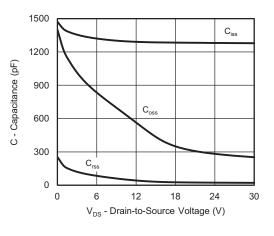
On-Resistance vs. Drain Current and Gate Voltage



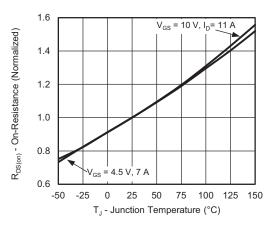
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

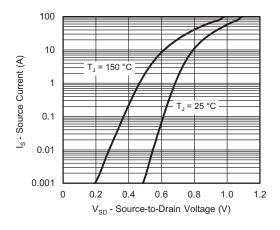
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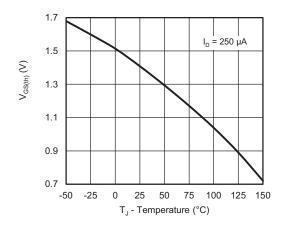
S16-1266-Rev. A, 27-Jun-16



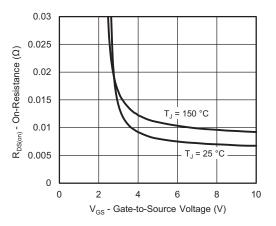
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



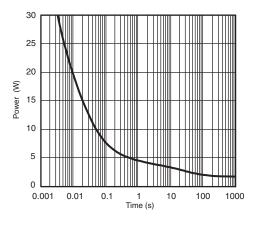
Source-Drain Diode Forward Voltage



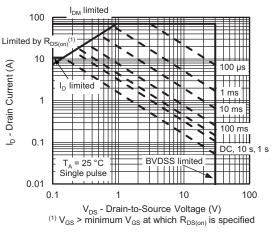
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

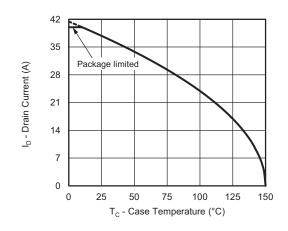


Safe Operating Area, Junction-to-Ambient

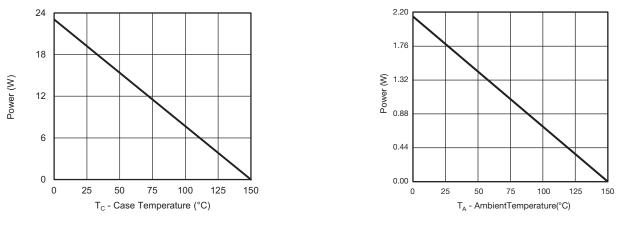
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a



Power, Junction-to-Case

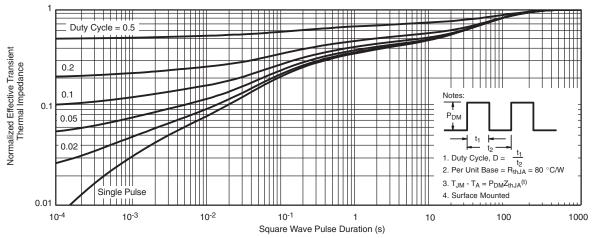
Power, Junction-to-Ambient

Note

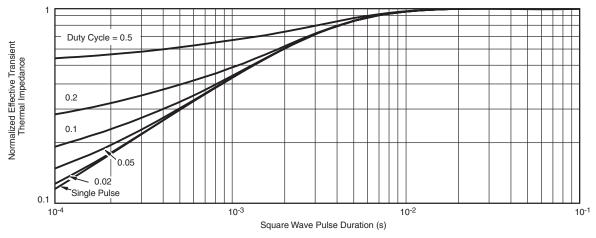
a. The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

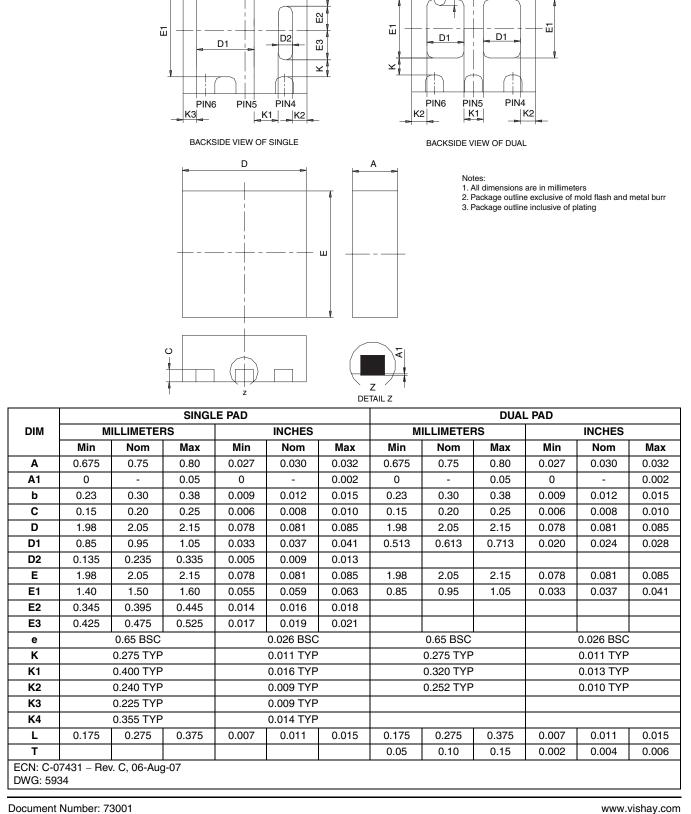






Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67408.



PowerPAK[®] SC70-6L

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b PIN2 PIN1 PIN3 _ ₹

Package Information

b

PIN3

__ ₿

PIN2

PIN1

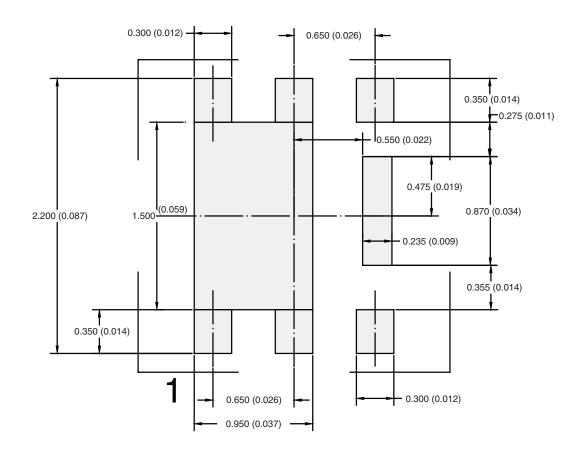
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RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC70-6L Single



Dimensions in mm/(Inches)

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